



# ULTRA LOW PHASE NOISE DISTRIBUTED AMPLIFIER, 2 - 18 GHz

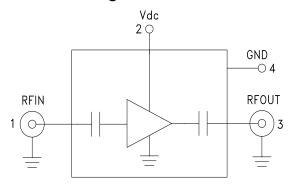


# Typical Applications

The HMC-C050 is ideal for:

- Microwave Radio
- Military & Space
- Test Instrumentation
- VSAT

## **Functional Diagram**



#### **Features**

Ultra Low Phase Noise: -160 dBc/Hz @ 10 kHz

Noise Figure: 5 dB

Gain: 13.5 dB

Output IP3: +22.5 dBm

50 Ohm Matched Input/Output

Single Supply Voltage: +5V Hermetically Sealed Module

Field Replaceable SMA Connectors

-55 °C to +85 °C Operating Temperature

## **General Description**

The HMC-C050 is a GaAs HBT Ultra Low Noise Amplifier in a miniature, hermetic module designed to operate between 2 and 18 GHz. This high dynamic range amplifier module provides 13.5 dB of gain, 5 dB noise figure and up to +22.5 dBm of OIP3 with a single supply of +5V. The ultra low phase noise contribution of -160 dBc/Hz, enables superior modulation accuracy within transceiver architectures. The wideband distributed amplifier I/O's are internally matched to 50 Ohms and DC blocked for robust performance. The module features removable SMA connectors which can be detached to allow direct connection of the I/O pins to a microstrip or coplanar circuit.

# Electrical Specifications, $T_A = +25^{\circ}$ C, Vdc = +5V

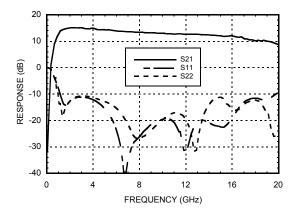
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		8 - 12.5			2 - 18		GHz
Gain	10.5	13.5		9.5	12.5		dB
Gain Flatness		±1.2			±2.2		dB
Gain Variation Over Temperature		0.021			0.027		dB/ °C
Noise Figure		4.5			6.5		dB
Input Return Loss		18			16		dB
Output Return Loss		17			15		dB
Output Power for 1 dB Compression (P1dB)	13	15		8	13		dBm
Saturated Output Power (Psat)		18.5			16		dBm
Output Third Order Intercept (IP3)		22.5			20		dBm
Phase Noise @ 100 Hz		-140			-150		dBc/Hz
Phase Noise @ 1 kHz		-150			-150		dBc/Hz
Phase Noise @ 10 kHz		-160			-150		dBc/Hz
Phase Noise @ 1 MHz		-165			-160		dBc/Hz
Supply Current		80	104		80	104	mA



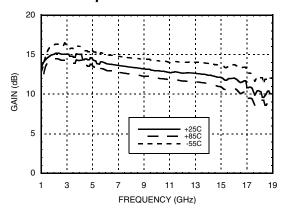


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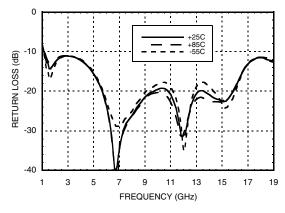
#### Gain & Return Loss



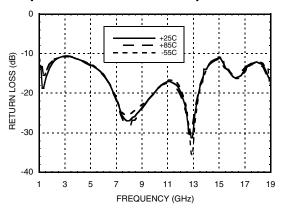
#### Gain vs. Temperature



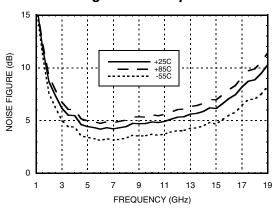
## Input Return Loss vs. Temperature



# Output Return Loss vs. Temperature



## Noise Figure vs. Temperature

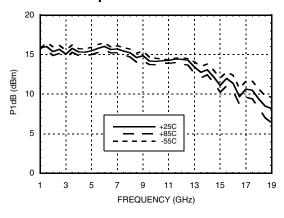




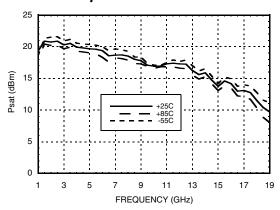


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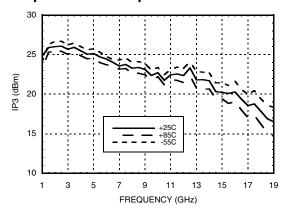
#### P1dB vs. Temperature



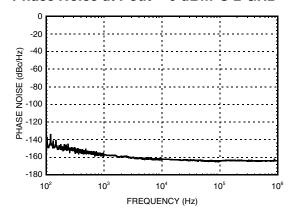
#### Psat vs. Temperature



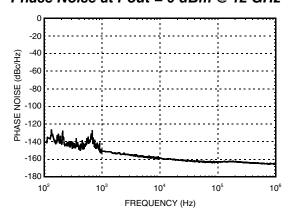
#### Output IP3 vs. Temperature



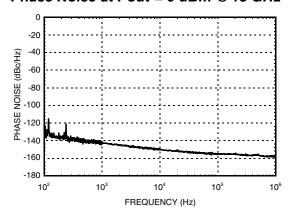
#### Phase Noise at Pout = 0 dBm @ 2 GHz



### Phase Noise at Pout = 0 dBm @ 12 GHz



#### Phase Noise at Pout = 0 dBm @ 18 GHz

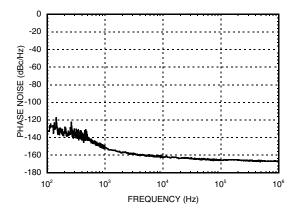




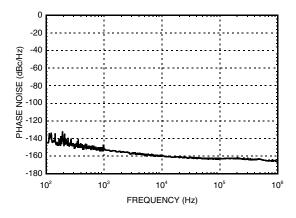


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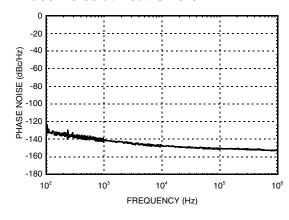
#### Phase Noise at Psat @ 2 GHz



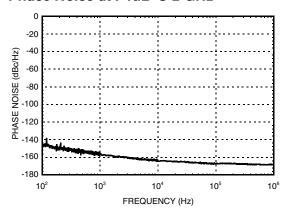
#### Phase Noise at Psat @ 12 GHz



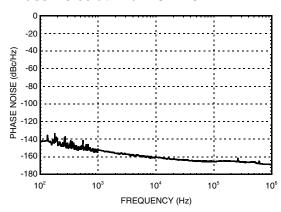
#### Phase Noise at Psat @ 18 GHz



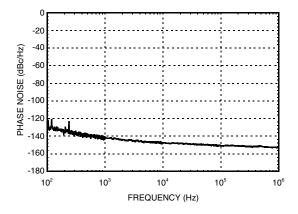
#### Phase Noise at P1dB @ 2 GHz



#### Phase Noise at P1dB @ 12 GHz



#### Phase Noise at P1dB @ 18 GHz







# **ULTRA LOW PHASE NOISE DISTRIBUTED AMPLIFIER, 2 - 18 GHz**

## **Absolute Maximum Ratings**

Bias Supply Voltage (Vdc)	+7V	
RF Input Power (RFIN)	+15 dBm	
Continuous Pdiss (T = 85 °C)	0.65W	
Channel Temperature	175 °C	
Thermal Resistance	91.5 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-55 to +85 °C	



## **Pin Descriptions**

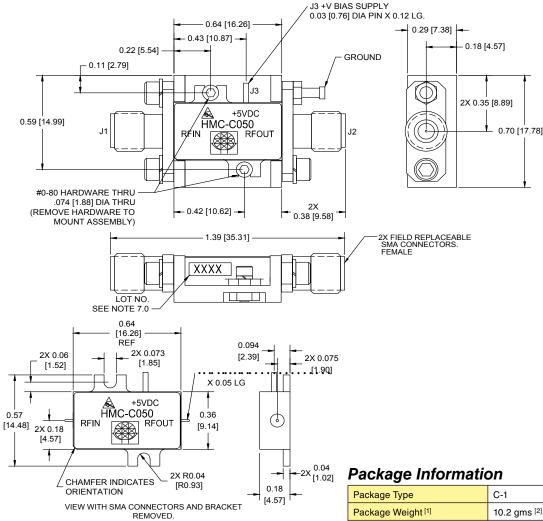
Pin Number	Function	Description	Interface Schematic	
1	RFIN & RF Ground	RF input connector, coaxial female, field replaceable. This pin is AC coupled and matched to 50 Ohms.	RFINO—  -	
2	Vdc	Power supply voltage for the amplifier.	Vdc ————————————————————————————————————	
3	RFOUT & RF Ground	RF output connector, coaxial female, field replaceable. This pin is AC coupled and matched to 50 Ohms.	→   → RFOUT	
4	GND	Power supply ground.	⊖ GND =	





# **ULTRA LOW PHASE NOISE DISTRIBUTED AMPLIFIER, 2 - 18 GHz**

### **Outline Drawing**



Package Type	C-1
Package Weight [1]	10.2 gms <sup>[2]</sup>
Spacer Weight	N/A

- [1] Includes the connectors
- [2] ±1 gms Tolerance

#### NOTES:

- 1. PACKAGE, LEADS, COVER MATERIAL: KOVAR™
- 2. SPACER MATERIAL: ALUMINUM
- 3. PLATING: ELECTROLYTIC GOLD 50 MICROINCHES MIN., OVER ELECTROLYTIC NICKEL 75 MICROINCHES MIN.
- 4. ALL DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. TOLERANCES ±.005 [0.13] UNLESS OTHERWISE SPECIFIED.
- 6. FIELD REPLACEABLE SMA CONNECTORS. TENSOLITE 5602-5CCSF OR EQUIVALENT.
- ⚠TO MOUNT MODULE TO SYSTEM PLATFORM REPLACE 0 -80 HARDWARE WITH DESIRED MOUNTING SCREWS.